

BYT 13-600 \rightarrow 1000

FAST RECOVERY RECTIFIER DIODES

- SOFT RECOVERY
- VERY HIGH VOLTAGE
- SMALL RECOVERY CHARGE



APPLICATIONS

- ANTISATURATION DIODES FOR TRANSIS-TOR BASE DRIVE
- SNUBBER DIODES

ABSOLUTE MAXIMUM RATINGS (limiting values)

Symbol	Parameter		Value	Unit		
I _{FRM}	Repetive Peak Forward Current	$t_p \le 20 \mu s$	50	А		
I _{F (AV)}	Average Forward Current *	$T_a = 55^{\circ}C$ $\delta = 0.5$	3	A		
I _{FSM}	Surge non Repetitive Forward Current	t _p = 10ms Sinusoidal	100	A		
P _{tot}	Power Dissipation *	3.75	W			
T _{stg} T _j	Storage and Junction Temperature Range- 40 to + 150- 40 to + 150					
TL	Maximum Lead Temperature for Soldering during 10s at 4mm 230 from Case 230					

Symbol	Parameter		Unit		
	i didiletti	600	800	1000	onic
V _{RRM}	Repetitive Peak Reverse Voltage	600	800	1000	V

THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
R _{th (j} - a)	Junction-ambient*	25	°C/W

* On infinite heatsink with 10mm lead length.

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ELECTRICAL CHARACTERISTICS

STATIC CHARACTERISTICS

Synbol	Test Conditions Min. Typ.						Unit
I _R	$T_j = 25^{\circ}C$	$V_R = V_{RRM}$				20	μA
VF	$T_j = 25^{\circ}C$	I _F = 3A				1.3	V

RECOVERY CHARACTERISTICS

Symbol	Test Conditions Min. Typ							Unit
t _{rr}	$T_j = 25^{\circ}C$	$I_{\rm F} = 0.5 {\rm A}$	I _R = 1A	$I_{rr} = 0.25A$			150	ns

To evaluate the conduction losses use the following equations:

 $V_F = 0.95 + 0.050 I_F$ $P = 0.95 \times I_{F(AV)} + 0.050 I_{F}^{2}(RMS)$

Figure 1. Maximum average power dissipation versus average forward current.



Figure 3. Thermal resistance versus lead length.



Figure 2. Average forward current versus ambient temperature.



Mounting n°1 INFINITE HEATSINK

Mounting n°2 PRINTED CIRCUIT

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Figure 4. Transient thermal impedance junction-ambient for mounting n^2 versus pulse duration (L = 10 mm).



Figure 5. Peak forward current versus peak forward voltage drop (maximum values).



Figure 6. Capacitance versus reverse applied voltage



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Figure 7. Non repetitive surge peak current versus number of cycles



PACKAGE MECHANICAL DATA

DO-201AD (Plastic)



REF.	DIMENSIONS				NOTES		
	Millimeters		Millimeters		Inc	hes	
	Min.	Max.	Min.	Max.			
А		9.50		0.374	1 - The lead diameter \varnothing D is not controlled over zone E		
В	25.40		1.000				
ØC		5.30		0.209	12 - The minimum axial lengh within which the device may be placed with its leads bent at right angles is 0.59"(15 mm)		
ØD		1.30		0.051			
E		1.25		0.049			

- Marking : type number, white band indicates cathode
- Cooling method : by convection (method A)
- Weight : 1.166g

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